## Surface Mount Schottky Power Rectifier

### MBRS360T3G, MBRS360BT3G, NRVBS360T3G, NRVBS360BT3G, NRVBS360BNT3

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

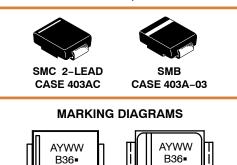
#### Features

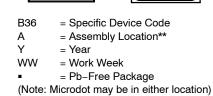
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- NRVBS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable\*
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Mechanical Characteristics**

- Case: Epoxy, Molded, Epoxy Meets UL 94 V–0
- Weight: 217 mg (Approximately), SMC 95 mg (Approximately), SMB
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band on Plastic Body Indicates Cathode Lead
- Device Meets MSL 1 Requirements
- ESD Ratings:
  - Machine Model, C
  - Human Body Model, 3B

#### SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES, 60 VOLTS





\*\*The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRS360T3G	SMC (Pb-Free)	2,500 / Tape & Reel
MBRS360BT3G	SMB (Pb-Free)	2,500 / Tape & Reel
NRVBS360T3G*	SMC (Pb-Free)	2,500 / Tape & Reel
NRVBS360BNT3G*	SMB (Pb–Free)	2,500 / Tape & Reel

#### DISCONTINUED (Note 1)

NRVBS360BT3G*	SMB (Pb-Free)	2,500 / Tape & Reel
NRVBS360BT3G	SMB	2,500 /
-VF01*	(Pb-Free)	Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

 DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current	I <sub>F(AV)</sub>	3.0 @ T <sub>L</sub> = 137°C 4.0 @ T <sub>L</sub> = 127°C	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	125	A
Storage Temperature Range	T <sub>stg</sub>	– 65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	– 65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

#### **THERMAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2) SMC Package SMB Package	R <sub>θJL</sub>	11 15	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2) SMC Package SMB Package	R <sub>θJA</sub>	136 145	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3) SMC Package SMB Package (Note 4)	R <sub>θJA</sub>	71 73	°C/W

#### LECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 5) ( $i_F = 3.0 \text{ A}, T_J = 25^{\circ}\text{C}$ )	V <sub>F</sub>	0.63	V
Maximum Instantaneous Reverse Current (Note 5) (Rated dc Voltage, $T_J = 25^{\circ}$ C) (Rated dc Voltage, $T_J = 100^{\circ}$ C)	İR	0.03 3.0	mA

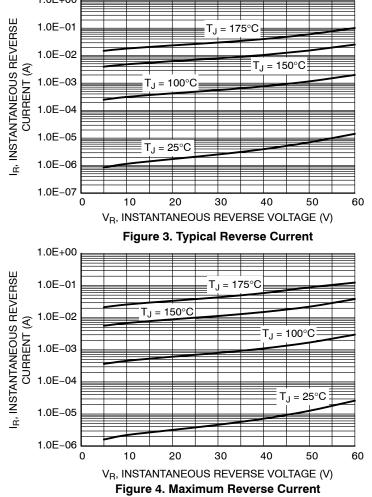
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Mounted with minimum recommended pad size, PC Board FR4.

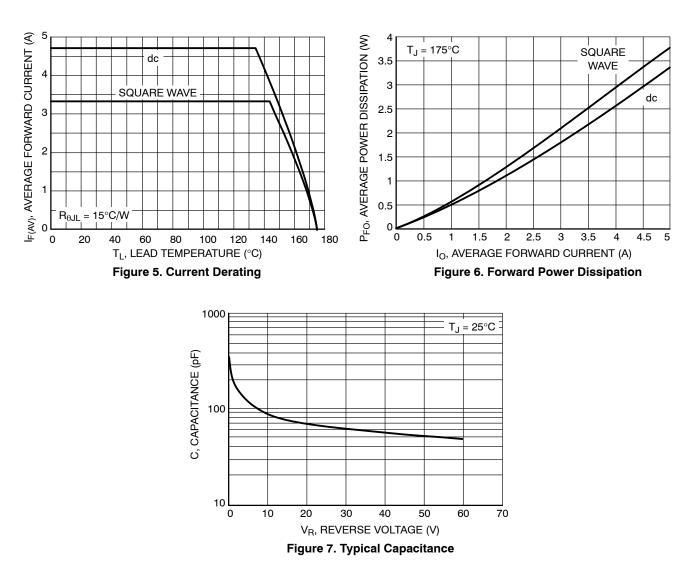
1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.
Typical Value; 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

5. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

**TYPICAL ELECTRICAL CHARACTERISTICS** 

#### 10 10 IF, INSTANTANEOUS FORWARD IF, INSTANTANEOUS FORWARD $T_J = 150^{\circ}C$ T<sub>J</sub> = 175°C T<sub>J</sub> = 175°C CURRENT (A) 1 (A) CURRENT (A) T<sub>J</sub> = 150°C $T_J = 100^{\circ}C$ T<sub>J</sub> = 25°C $T_J = 25^{\circ}C$ $T_{\rm J} = 100^{\circ}$ $T_J = -40^{\circ}C$ $T_J = -40^\circ C$ 0.01 0.01 0.0 0.2 0.6 0.8 0.0 0.8 0.4 0.2 0.6 0.4 V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 1. Typical Forward Voltage Figure 2. Maximum Forward Voltage 1.0E+00 1.0E-01 T<sub>J</sub> = 175°C





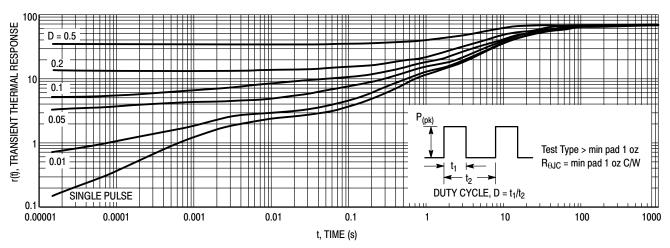


Figure 8. Thermal Response, Junction-to-Ambient, SMC Package

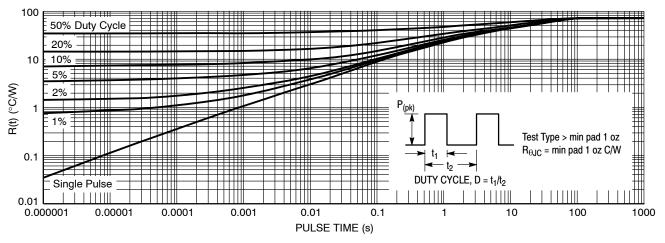
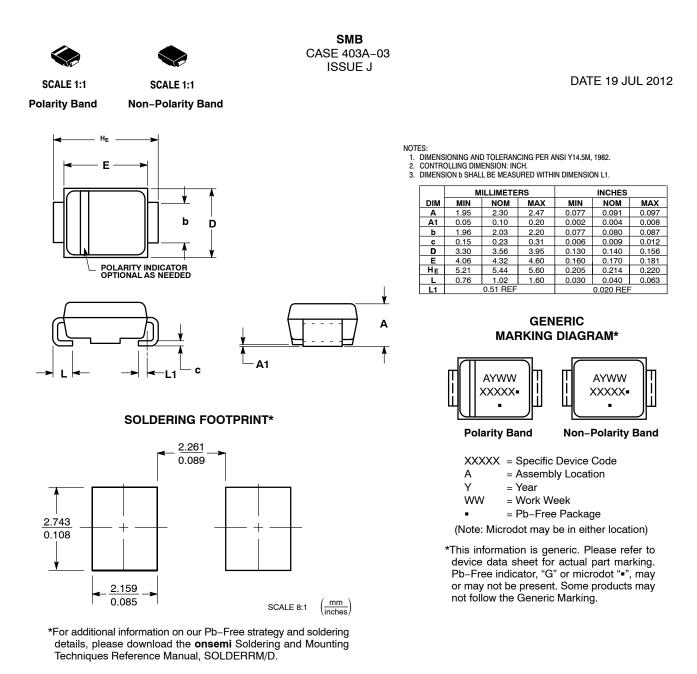


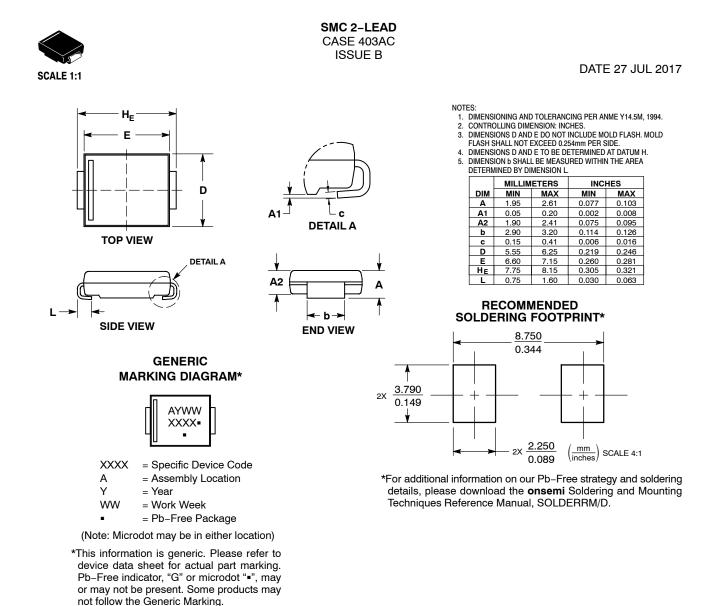
Figure 9. Typical Thermal Response, Junction-to-Ambient, SMB Package

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